

- 36 -

ABSTRACT OF THE DISCLOSURE

5 A semiconductor laser chip has an emission facet
for emitting a laser beam. A sub-mount has a first
surface and at least one second surface vertical to the
first surface. The semiconductor laser chip is
provided on the first surface of the sub-mount. The
10 second surface arranged in line with the emission facet
of the semiconductor laser chip is inclined at an angle
of 3 to 30 degrees. The inclined second surface
reflects reflection light of a sub-beam diffracted from
a main beam emitted by the semiconductor laser chip.

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